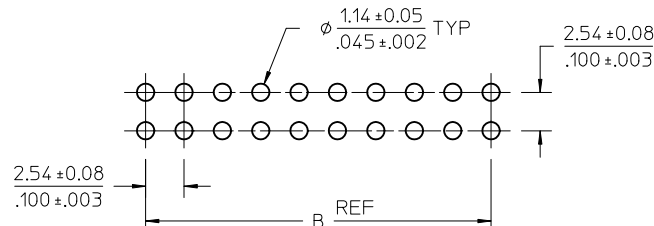
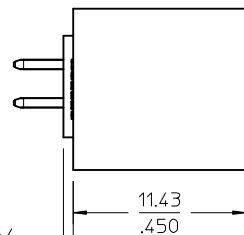
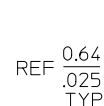
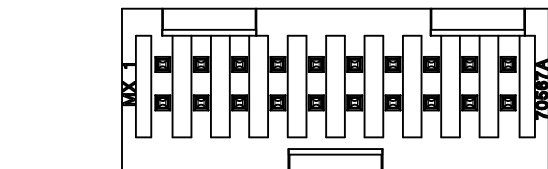
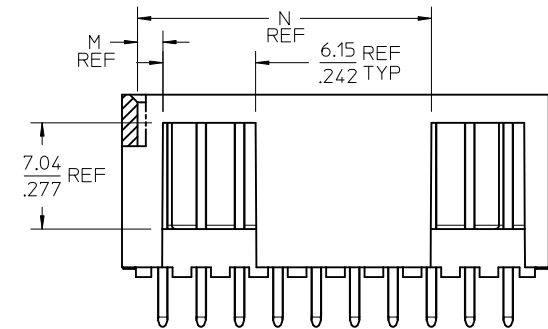
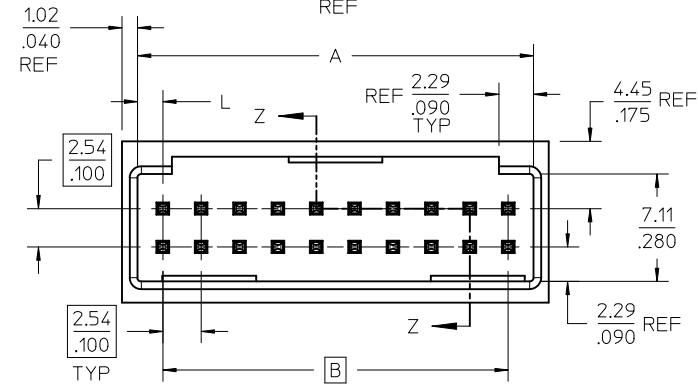
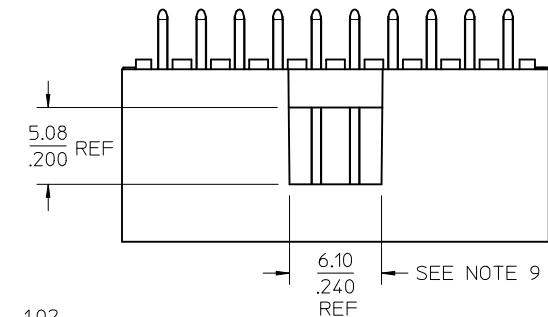
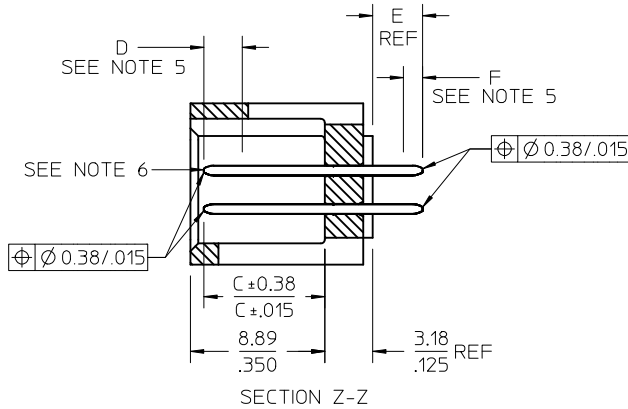


OPTION A



PCB LAYOUT: COMPONENT SIDE
TYPICAL PCB THICKNESS: 2.36/.093



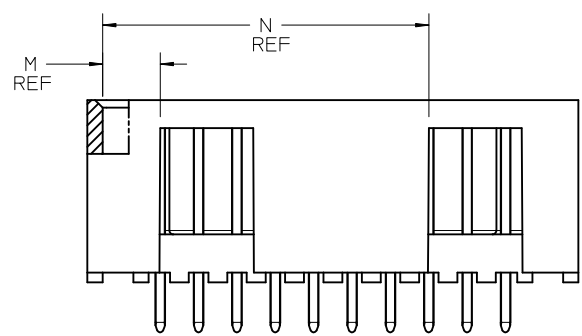
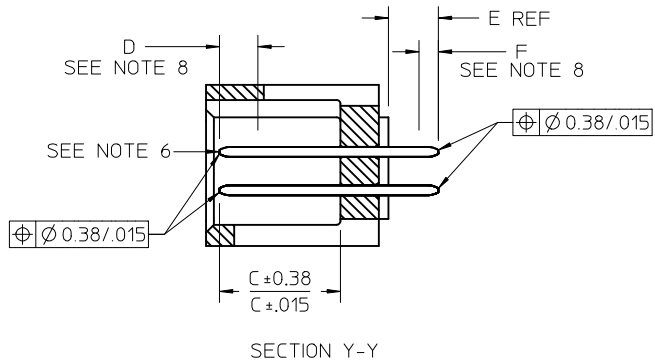
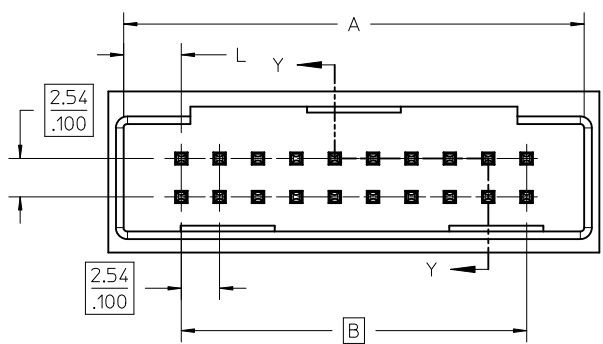
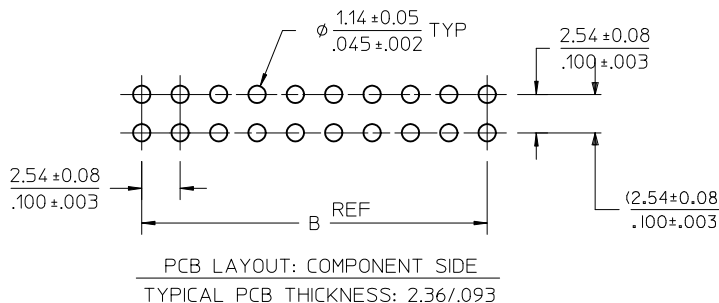
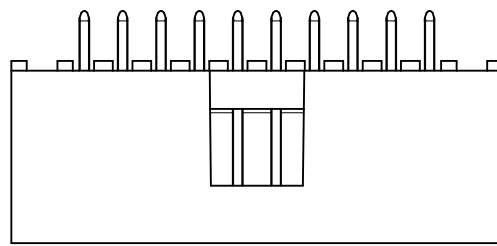
NOTES:

- MATERIAL: SHROUDED WAFER: GLASS FILLED, LIQUID CRYSTAL POLYMER, COLOR: BLACK, 94V-0. PINS: COPPER ALLOY.
- PLATING:
 - TIN 0.000381/.000150 MINIMUM TIN, OVER NICKEL UNDERPLATE OVERALL
 - 15 GOLD 0.00038/.000015 MINIMUM GOLD PLATE IN SELECTED AREA
 - 0.00191/.000075 MINIMUM TIN IN SELECTED AREA OVER NICKEL UNDERPLATE OVERALL
 - 30 GOLD 0.00076/.000030 MINIMUM GOLD PLATE IN SELECTED AREA
 - 0.00191/.000075 MINIMUM TIN IN SELECTED AREA, OVER NICKEL UNDERPLATE OVERALL
- PRODUCT SPECIFICATION: PS-70567.
- PACKAGING: SEE CHARTS
- MEASURE POINT FOR PLATING THICKNESS.
- PIN PUSHOUT FORCE: 4 LBS. MINIMUM IN DIRECTION INDICATED.
- FOR ILLUSTRATION PURPOSES, 20 (DUAL 10) CIRCUIT SIZE HEADER SHOWN.
- PIN SOLDERABILITY PER MOLEX SPEC. SMES-152.
- WINDOW NOT AVAILABLE ON 6 OR 8 CIRCUIT SIZE.
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

CKT	DIM A	DIM B	DIM L	DIM M	DIM N
06	8.43	5.08	1.68	1.68	
	.332	.200	.066	.066	
08	10.97	7.62	1.68	1.68	
	.432	.300	.066	.066	
10	13.51	10.16	1.68	4.22	
	.532	.400	.066	.166	
12	16.05	12.70	1.68	4.22	
	.632	.500	.066	.166	
14	18.59	15.24	1.68	6.76	
	.732	.600	.066	.266	
16	21.13	17.78	1.68	6.76	
	.832	.700	.066	.266	
18	23.67	20.32	1.68	9.30	
	.932	.800	.066	.366	
20	26.21	22.86	1.68	1.68	19.46
	1.032	.900	.066	.066	.766
22	28.75	25.40	1.68	1.68	22.00
	1.132	1.000	.066	.066	.866
24	31.29	27.94	1.68	1.68	24.54
	1.232	1.100	.066	.066	.966
26	33.83	30.48	1.68	1.68	27.08
	1.332	1.200	.066	.066	1.066
28	36.37	33.02	1.68	1.68	29.62
	1.432	1.300	.066	.066	1.166
30	38.91	35.56	1.68	1.68	32.16
	1.532	1.400	.066	.066	1.266
32	41.45	38.10	1.68	1.68	34.70
	1.632	1.500	.066	.066	1.366
34	43.99	40.64	1.68	1.68	37.24
	1.732	1.600	.066	.066	1.466
36	46.53	43.18	1.68	1.68	39.78
	1.832	1.700	.066	.066	1.566
38	49.07	45.72	1.68	1.68	42.32
	1.932	1.800	.066	.066	1.666
40	51.61	48.26	1.68	1.68	44.86
	2.032	1.900	.066	.066	1.766
42	54.15	50.80	1.68	1.68	47.40
	2.132	2.000	.066	.066	1.866
44	56.69	53.34	1.68	1.68	49.94
	2.232	2.100	.066	.066	1.966
46	59.23	55.88	1.68	1.68	52.48
	2.332	2.200	.066	.066	2.066
48	61.77	58.42	1.68	1.68	55.02
	2.432	2.300	.066	.066	2.166
50	64.31	60.96	1.68	1.68	57.56
	2.532	2.400	.066	.066	2.266
52	66.85	63.50	1.68	1.68	60.10
	2.632	2.500	.066	.066	2.366
54	69.39	66.04	1.68	1.68	62.64
	2.732	2.600	.066	.066	2.466
56	71.93	68.58	1.68	1.68	65.18
	2.832	2.700	.066	.066	2.566
58	74.47	71.12	1.68	1.68	67.72
	2.932	2.800	.066	.066	2.666
60	77.01	73.66	1.68	1.68	70.26
	3.032	2.900	.066	.066	2.766
62	79.55	76.20	1.68	1.68	72.80
	3.132	3.000	.066	.066	2.866
64	82.09	78.74	1.68	1.68	75.34
	3.232	3.100	.066	.066	2.966
66	84.63	81.28	1.68	1.68	77.88
	3.332	3.200	.066	.066	3.066
68	87.17	83.82	1.68	1.68	80.42
	3.432	3.300	.066	.066	3.166
70	89.71	86.36	1.68	1.68	82.96
	3.532	3.400	.066	.066	3.266
72	92.25	88.90	1.68	1.68	85.50
	3.632	3.500	.066	.066	3.366

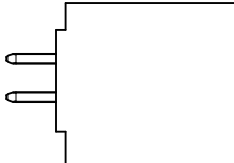
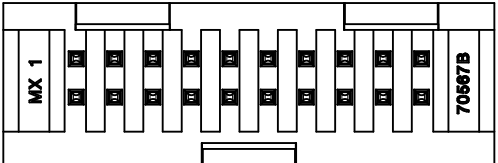
CORRECT PCB HOLE SIZE EC NO: UCP2011-0294 DRWINAS BARRA 2010/08/02 CHYKD:DRORGAN 1988/03/10 APPR:MBANAKIS 2010/08/03	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE MM/IN	SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
		mm INCH	DRAWN BY DATE EIK 1988/03/10	CHECKED BY DATE EIK 1988/03/10	APPROVED BY DATE SMILLER 2010/03/31	MATERIAL NO. SEE TABLE	DOCUMENT NO. SDA-70567-****
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		ANGULAR ±1/2°		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

OPTION B



- NOTES:
- MATERIAL: SHROUDED WAFER: 30% G.F. LCP, COLOR: BLACK, 94V-0. PINS: COPPER ALLOY.
 - PLATING:
 TIN - (0.00381)/.000150 MINIMUM TIN OVER NICKEL UNDERPLATE OVERALL
 15 GOLD - (0.000381)/.000015 MINIMUM GOLD PLATE IN SELECTED AREA
 (0.00191)/.000075 MINIMUM TIN IN SELECTED AREA, OVER NICKEL UNDERPLATE OVERALL
 30 GOLD - (0.000761)/.000030 MINIMUM GOLD PLATE IN SELECTED AREA
 (0.00191)/.000075 MINIMUM TIN IN SELECTED AREA, OVER NICKEL UNDERPLATE OVERALL
 - PRODUCT SPECIFICATION: PS-70567.
 - PACKAGING: SEE CHARTS
 - PIN PUSHOUT FORCE: 4 LBS. MIN IN DIRECTION INDICATED.
 - FOR ILLUSTRATION PURPOSES, 20 (DUAL 10) CIRCUIT SIZE HEADER SHOWN.
 - PIN SOLDERABILITY PER MOLEX SPEC. SMES-152.
 - MEASURE POINT FOR PLATING THICKNESS.
 - WINDOW IS NOT AVAILABLE ON 6 CIRCUIT.
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.
 - SEE SHEET 1 FOR ALL OTHER DIMENSIONS

CKT	DIM A	DIM B	DIM L	DIM M	DIM N
06	12.70 .500	5.08 .200	3.81 .150	3.81 .150	---
08	15.24 .600	7.62 .300	3.81 .150	3.81 .150	---
10	17.78 .700	10.16 .400	3.81 .150	6.35 .250	---
12	20.32 .800	12.70 .500	3.81 .150	6.35 .250	---
14	22.86 .900	15.24 .600	3.81 .150	8.89 .350	---
16	25.40 1.000	17.78 .700	3.81 .150	8.89 .350	---
18	27.94 1.100	20.32 .800	3.81 .150	11.43 .450	---
20	30.48 1.200	22.86 .900	3.81 .150	3.81 .150	21.59 .850
22	33.02 1.300	25.40 1.000	3.81 .150	3.81 .150	24.13 .950
24	35.56 1.400	27.94 1.100	3.81 .150	3.81 .150	26.67 1.050
26	38.10 1.500	30.48 1.200	3.81 .150	3.81 .150	29.21 1.150
28	40.64 1.600	33.02 1.300	3.81 .150	3.81 .150	31.75 1.250
30	43.18 1.700	35.56 1.400	3.81 .150	3.81 .150	34.29 1.350
32	45.72 1.800	38.10 1.500	3.81 .150	3.81 .150	36.83 1.450
34	48.26 1.900	40.64 1.600	3.81 .150	3.81 .150	39.37 1.550
36	50.80 2.000	43.18 1.700	3.81 .150	3.81 .150	41.91 1.650
38	53.34 2.100	45.72 1.800	3.81 .150	3.81 .150	44.45 1.750
40	55.88 2.200	48.26 1.900	3.81 .150	3.81 .150	46.99 1.850
42	58.42 2.300	50.80 2.000	3.81 .150	3.81 .150	49.53 1.950
44	60.96 2.400	53.34 2.100	3.81 .150	3.81 .150	52.07 2.050
46	63.50 2.500	55.88 2.200	3.81 .150	3.81 .150	54.61 2.150
48	66.04 2.600	58.42 2.300	3.81 .150	3.81 .150	57.15 2.250
50	68.58 2.700	60.96 2.400	3.81 .150	3.81 .150	59.69 2.350
52	71.12 2.800	63.50 2.500	3.81 .150	3.81 .150	62.23 2.450
54	73.66 2.900	66.04 2.600	3.81 .150	3.81 .150	64.77 2.550
56	76.20 3.000	68.58 2.700	3.81 .150	3.81 .150	67.31 2.650
58	78.74 3.100	71.12 2.800	3.81 .150	3.81 .150	69.85 2.750
60	81.28 3.200	73.66 2.900	3.81 .150	3.81 .150	72.39 2.850
62	83.82 3.300	76.20 3.000	3.81 .150	3.81 .150	74.93 2.950
64	86.36 3.400	78.74 3.100	3.81 .150	3.81 .150	77.47 3.050
66	88.90 3.500	81.28 3.200	3.81 .150	3.81 .150	80.01 3.150
68	91.44 3.600	83.82 3.300	3.81 .150	3.81 .150	82.55 3.250
70	93.98 3.700	86.36 3.400	3.81 .150	3.81 .150	85.09 3.350
72	96.52 3.800	88.90 3.500	3.81 .150	3.81 .150	87.63 3.450

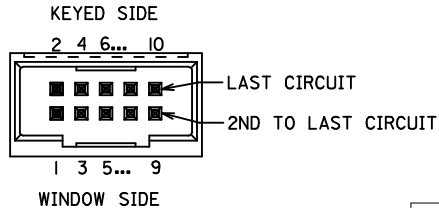


CORRECT PCB HOLE SIZE IEC NO: UCP2011-0294 DRWN:MS BARRA 2010/08/02 CHKD:DWORGAN 1988/03/10 APPR:MBANKS 2010/08/03	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± .005 2 PLACES ± .13 ± .010 1 PLACE ± 0.25 ± --- ANGULAR ±1/2°		DIMENSION STYLE MM/IN DRAWN BY DATE EIK 1988/03/10 CHECKED BY DATE EIK 1988/03/10 APPROVED BY DATE MILLER 2010/03/31		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE TABLE		DOCUMENT NO. SDA-70567-****		SHEET NO. 2 OF 5			
		MOLEX MOLEX INCORPORATED								THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
		4 SIDES SHROUDED HEADER HIGH TEMP, (2.54)/.100 GRID W/ (.64)/.025 PINS									

SPECIAL - WITH VOIDS

CKTS SIZE	ENGINEERING NUMBER A-70567	EDP NUMBER	E REF.	C $\pm \frac{.015}{(0.38)}$	K $\pm \frac{.015}{(0.38)}$	VOID CKTS	CONNECTOR END PLATING		P.C. BOARD END PLATING		PACKAGING INFORMATION PK-70873-
							TYPE	D MEAS.	TYPE	F MEAS.	
10	-9003	70567-9003	.130 (3.30)	.315 (8.00)	.415 (10.54)	10	GOLD	.100 (2.54)	TIN	.050 (.127)	0018

CIRCUIT NUMBERING CONVENTION
(10 CKT USED AS EXAMPLE)



SEE SHEETS 1 & 2 EC NO: UCP2011-0294 DRWN:MSIBARRA 2010/08/02 CHKD:DMORGAN 1988/03/10 APPR:MBANKIS 2010/08/03	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED) <table border="1"> <tr><th>mm</th><th>INCH</th></tr> <tr><td>4 PLACES ± ---</td><td>± ---</td></tr> <tr><td>3 PLACES ± ---</td><td>± .005</td></tr> <tr><td>2 PLACES ± 0.13</td><td>± .010</td></tr> <tr><td>1 PLACE ± 0.25</td><td>± ---</td></tr> </table>	mm	INCH	4 PLACES ± ---	± ---	3 PLACES ± ---	± .005	2 PLACES ± 0.13	± .010	1 PLACE ± 0.25	± ---	DIMENSION STYLE MM/IN DRAWN BY DATE EIK 1988/03/10 CHECKED BY DATE EIK 1988/03/10 APPROVED BY DATE MILLER 2010/03/31	SCALE 4:1 DESIGN UNITS INCH THIRD ANGLE PROJECTION	TITLE 4 SIDES SHROUDED HEADER HIGH TEMP. (2.54)/.100 GRID W/ (.64)/.025 PINS
	mm	INCH													
	4 PLACES ± ---	± ---													
	3 PLACES ± ---	± .005													
2 PLACES ± 0.13	± .010														
1 PLACE ± 0.25	± ---														
MATERIAL NO. SEE TABLE DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MOLEX INCORPORATED SDA-70567-****	SHEET NO. 5 OF 5													
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION															
SIZE C															



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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Факс: 8 (812) 320-02-42

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